

January 2008

# 74LVT2245, 74LVTH2245 Low Voltage Octal Bidirectional Transceiver with 3-STATE Inputs/Outputs and 25 $\Omega$ Series Resistors in the B Port Outputs

## **Features**

- Input and output interface capability to systems at 5V V<sub>CC</sub>
- Equivalent  $25\Omega$  series resistor on B Port outputs
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH2245), also available without bushold feature (74LVT2245)
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink –12mA/+12mA on B Port, –32mA/+64mA on A Port
- Latch-up performance exceeds 500mA
- ESD performance:
  - Human-body model > 2000V
  - Machine model > 200V
  - Charged-device model > 1000V

# **General Description**

The LVT2245 and LVTH2245 contain eight non-inverting bidirectional buffers with 3-STATE outputs and are intended for bus-oriented applications. The Transmit/Receive (T/ $\overline{R}$ ) input determines the direction of data flow through the bidirectional transceiver. Transmit (active-HIGH) enables data from A Ports to B Ports; Receive (active-LOW) enables data from B Ports to A Ports. The Output Enable input, when HIGH, disables both A and B Ports by placing them in a high impedance state. The equivalent 25 $\Omega$ -series resistor in the B Port helps reduce output overshoot and undershoot.

The LVTH2245 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These transceivers are designed for low voltage (3.3V)  $V_{CC}$  applications, but with the capability to provide a TTL interface to a 5V environment. The LVT2245 and LVTH2245 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

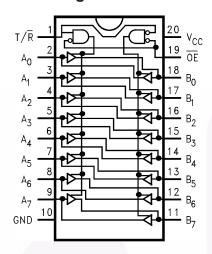
# **Ordering Information**

| Order Number  | Package<br>Number | Package Description   |
|---------------|-------------------|---|
| 74LVT2245WM   | M20B              | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide  |
| 74LVT2245SJ   | M20D              | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide               |
| 74LVT2245MTC  | MTC20             | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| 74LVTH2245WM  | M20B              | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide  |
| 74LVTH2245SJ  | M20D              | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide               |
| 74LVTH2245MTC | MTC20             | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

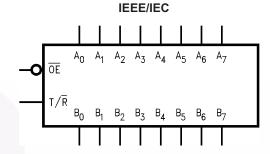
# **Connection Diagram**

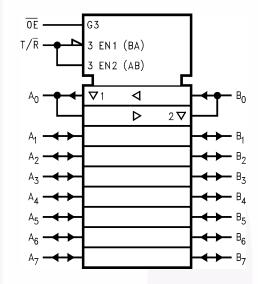


# **Pin Description**

| Pin<br>Names                   | Description                      |  |  |  |
|--------------------------------|----------------------------------|--|--|--|
| ŌĒ                             | Output Enable Input              |  |  |  |
| T/R                            | Transmit/Receive Input           |  |  |  |
| A <sub>0</sub> -A <sub>7</sub> | Side A Inputs or 3-STATE Outputs |  |  |  |
| B <sub>0</sub> –B <sub>7</sub> | Side B Inputs or 3-STATE Outputs |  |  |  |

# **Logic Symbols**





# **Truth Table**

| Inp | uts |                     |
|-----|-----|---------------------|
| ŌĒ  | T/R | Outputs             |
| L   | L   | Bus B Data to Bus A |
| L   | Н   | Bus A Data to Bus B |
| Н   | Х   | HIGH-Z State        |

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol           | Parameter   | Rating          |  |  |
|------------------|---|-----------------|--|--|
| V <sub>CC</sub>  | Supply Voltage                                      | -0.5V to +4.6V  |  |  |
| V <sub>I</sub>   | DC Input Voltage                                    | -0.5V to +7.0V  |  |  |
| Vo               | DC Output Voltage                                   |                 |  |  |
|                  | Output in 3-STATE                                   | -0.5V to +7.0V  |  |  |
|                  | Output in HIGH or LOW State <sup>(1)</sup>          | -0.5V to +7.0V  |  |  |
| I <sub>IK</sub>  | DC Input Diode Current, V <sub>I</sub> < GND        |                 |  |  |
| I <sub>OK</sub>  | DC Output Diode Current, V <sub>O</sub> < GND       | -50mA           |  |  |
| Io               | DC Output Current, V <sub>O</sub> > V <sub>CC</sub> |                 |  |  |
|                  | Output at HIGH State                                | 64mA            |  |  |
|                  | Output at LOW State                                 | 128mA           |  |  |
| I <sub>CC</sub>  | DC Supply Current per Supply Pin                    | ±64mA           |  |  |
| I <sub>GND</sub> | DC Ground Current per Ground Pin                    | ±128mA          |  |  |
| T <sub>STG</sub> | Storage Temperature                                 | −65°C to +150°C |  |  |

## Note:

1. IO Absolute Maximum Rating must be observed.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol          | Parameter  | Min                 | Max | Units |      |
|-----------------|--|---------------------|-----|-------|------|
| V <sub>CC</sub> | Supply Voltage                                   |                     | 2.7 | 3.6   | V    |
| VI              | Input Voltage                                    |                     | 0   | 5.5   | V    |
| I <sub>OH</sub> | HIGH-Level Output Current A Port                 |                     | //  | -32   | mA   |
|                 |  | B Port              |     | -12   |      |
| I <sub>OL</sub> | LOW-Level Output Current                         | A Port              |     | 64    | mA   |
|                 |  | B Port              |     | 12    |      |
| T <sub>A</sub>  | Free Air Operating Temperature                   | -40                 | +85 | °C    |      |
| Δt/ΔV           | Input Edge Rate, $V_{IN} = 0.8V-2.0V$ , $V_{CO}$ | <sub>2</sub> = 3.0V | 0   | 10    | ns/V |

## **DC Electrical Characteristics**

|  |                           |                             |                     |  | $T_A = -40$ °C to +85°C |            |       |
|--|---------------------------|-----------------------------|---------------------|--|-------------------------|------------|-------|
| Symbol   | Parame                    | ter                         | V <sub>CC</sub> (V) | Conditions   | Min.                    | Max.       | Units |
| V <sub>IK</sub>  | Input Clamp Diode Vo      | ltage                       | 2.7                 | I <sub>I</sub> = -18mA   |                         | -1.2       | V     |
| V <sub>IH</sub>  | Input HIGH Voltage        |                             | 2.7–3.6             | $V_0 \le 0.1V$ or  | 2.0                     |            | V     |
| V <sub>IL</sub>  | Input LOW Voltage         |                             | 2.7–3.6             | $V_O \ge V_{CC} - 0.1V$  |                         | 0.8        | V     |
| V <sub>OH</sub>  | Output HIGH Voltage       | A Port                      | 2.7                 | $I_{OH} = -8mA$  | 2.4                     |            | V     |
|  |                           |                             | 3.0                 | $I_{OH} = -32mA$   | 2.0                     |            |       |
|  |                           | B Port                      | 3.0                 | $I_{OH} = -12mA$   | 2.0                     |            |       |
|  |                           |                             | 2.7–3.6             | $I_{OH} = -100 \mu A$  | V <sub>CC</sub> -0.2    |            |       |
| V <sub>OL</sub>  | Output LOW Voltage        | A Port                      | 2.7                 | I <sub>OL</sub> = 24mA   |                         | 0.5        | V     |
|  |                           |                             | 3.0                 | I <sub>OL</sub> = 16mA   |                         | 0.4        |       |
|  |                           |                             | 3.0                 | $I_{OL} = 32mA$  |                         | 0.5        |       |
|  |                           |                             | 3.0                 | I <sub>OL</sub> = 64mA   |                         | 0.55       |       |
|  |                           | B Port                      | 3.0                 | I <sub>OL</sub> = 12mA   |                         | 0.8        |       |
|  |                           |                             | 2.7                 | $I_{OL} = 100 \mu A$   |                         | 0.2        |       |
| I <sub>I(HOLD)</sub> <sup>(2)</sup>                                    | Bushold Input Minimu      | m Drive                     | 3.0                 | $V_{I} = 0.8V$   | 75                      |            | μA    |
|  |                           |                             |                     | V <sub>I</sub> = 2.0V  | -75                     |            |       |
| l <sub>I(OD)</sub> <sup>(2)</sup> Bushold Input Over-D<br>Change State | rive Current to           | 3.0                         | (3)                 | 500  |                         | μA         |       |
|  | Change State              |                             |                     | (4)  | -500                    |            |       |
| I <sub>I</sub> Input C   | Input Current             |                             | 3.6                 | V <sub>I</sub> = 5.5V  |                         | 10         | μΑ    |
|  |                           | Control Pins                | 3.6                 | $V_I = 0V \text{ or } V_{CC}$  |                         | ±1         |       |
|  |                           | Data Pins                   | 3.6                 | $V_I = 0V$   |                         | -5         |       |
|  |                           |                             |                     | $V_I = V_{CC}$   |                         | 1          |       |
| I <sub>OFF</sub>   | Power Off Leakage Current |                             | 0                   | $0V \le V_I \text{ or } V_O \le 5.5V$  |                         | ±100       | μΑ    |
| I <sub>PU/PD</sub>   | Power Up/Down, 3-S        | TATE Current                | 0–1.5               | $V_O = 0.5V$ to 3.0V,  |                         | ±100       | μA    |
|  |                           |                             |                     | $V_I = GND \text{ or } V_{CC}$   |                         |            |       |
| I <sub>OZL</sub>   | 3-STATE Output Leak       | age Current                 | 3.6                 | $V_O = 0.5V$   |                         | -5         | μΑ    |
| I <sub>OZL</sub> <sup>(2)</sup>  | 3-STATE Output Leak       | age Current                 | 3.6                 | $V_0 = 0.0V$   |                         | <b>-</b> 5 | μA    |
| l <sub>ozh</sub>   | 3-STATE Output Leak       | age Current                 | 3.6                 | $V_0 = 3.0V$   |                         | 5          | μA    |
| I <sub>OZH</sub> <sup>(2)</sup>  | 3-STATE Output Leak       | age Current                 | 3.6                 | $V_0 = 3.6V$   |                         | 5          | μΑ    |
| I <sub>OZH</sub> +   | 3-STATE Output Leak       | age Current                 | 3.6                 | $V_{CC} < V_O \le 5.5V$  |                         | 10         | μΑ    |
| I <sub>CCH</sub>   | Power Supply Curren       | t                           | 3.6                 | Outputs High   |                         | 0.19       | mA    |
| I <sub>CCL</sub>   | Power Supply Curren       | t                           | 3.6                 | Outputs Low  |                         | 5          | mA    |
| I <sub>CCZ</sub>   | Power Supply Curren       | t                           | 3.6                 | Outputs Disabled   |                         | 0.19       | mA    |
| I <sub>CCZ</sub> +   | Power Supply Curren       | t                           | 3.6                 | $V_{CC} \le V_O \le 5.5V$ , Outputs Disabled                                   |                         | 0.19       | mA    |
| $\Delta I_{CC}$  | Increase in Power Su      | pply Current <sup>(5)</sup> | 3.6                 | One Input at V <sub>CC</sub> – 0.6V,<br>Other Inputs at V <sub>CC</sub> or GND |                         | 0.2        | mA    |

## Notes:

- 2. Applies to Bushold versions only (74LVTH2245).
- 3. An external driver must source at least the specified current to switch from LOW-to-HIGH.
- 4. An external driver must sink at least the specified current to switch from HIGH-to-LOW.
- 5. This is the increase in supply current for each input that is at the specified voltage level rather than  $V_{CC}$  or GND.

# Dynamic Switching Characteristics<sup>(6)</sup>

|                  |   |                     | Conditions                      | T,   | <sub>A</sub> = 25° | С    |       |
|------------------|---|---------------------|---------------------------------|------|--------------------|------|-------|
| Symbol           | Parameter                                       | V <sub>CC</sub> (V) | $C_L = 50 pF, R_L = 500 \Omega$ | Min. | Тур.               | Max. | Units |
| V <sub>OLP</sub> | Quiet Output Maximum<br>Dynamic V <sub>OL</sub> | 3.3                 | (7)                             |      | 0.8                |      | V     |
| V <sub>OLV</sub> | Quiet Output Minimum<br>Dynamic V <sub>OL</sub> | 3.3                 | (7)                             |      | -0.8               |      | V     |

## Notes:

- 6. Characterized in SOIC package. Guaranteed parameter, but not tested.
- 7. Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

## **AC Electrical Characteristics**

|                  | $T_A = -40$ °C to +85°C,<br>$C_L = 50$ pF, $R_L = 500$ $\Omega$ |              |           |                   |        |       |
|------------------|---|--------------|-----------|-------------------|--------|-------|
|                  |   | $V_{CC}=3.3$ | 3V ± 0.3V | V <sub>CC</sub> = | = 2.7V |       |
| Symbol           | Parameter   | Min.         | Max.      | Min.              | Max.   | Units |
| t <sub>PLH</sub> | Propagation Delay Data to B Port Output                         | 1.2          | 4.4       | 1.2               | 5.1    | ns    |
| t <sub>PHL</sub> |   | 1.2          | 4.4       | 1.2               | 5.1    |       |
| t <sub>PLH</sub> | Propagation Delay Data to A Port Output                         | 1.2          | 3.6       | 1.2               | 4.0    | ns    |
| t <sub>PHL</sub> |   | 1.2          | 3.5       | 1.2               | 4.0    |       |
| t <sub>PZH</sub> | Output Enable Time for B Port Output                            | 1.3          | 6.2       | 1.3               | 7.3    | ns    |
| t <sub>PZL</sub> |   | 1.7          | 6.2       | 1.7               | 7.3    |       |
| t <sub>PZH</sub> | Output Enable Time for A Port Output                            | 1.3          | 5.5       | 1.3               | 7.1    | ns    |
| t <sub>PZL</sub> |   | 1.7          | 5.7       | 1.7               | 6.7    |       |
| t <sub>PHZ</sub> | Output Disable Time for B Port Output                           | 2.0          | 5.9       | 2.0               | 6.5    | ns    |
| t <sub>PLZ</sub> |   | 2.0          | 5.4       | 2.0               | 5.7    |       |
| t <sub>PHZ</sub> | Output Disable Time for A Port Output                           | 2.0          | 5.9       | 2.0               | 6.5    | ns    |
| t <sub>PLZ</sub> |   | 2.0          | 5.0       | 2.0               | 5.1    |       |
| toshl, toshh     | A Port Output to Output Skew <sup>(8)</sup>                     |              | 1.0       |                   | 1.0    | ns    |
| toshl, toslh     | B Port Output to Output Skew <sup>(8)</sup>                     |              | 1.0       |                   | 1.0    | ns    |

## Note:

8. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

# Capacitance<sup>(9)</sup>

| Symbol           | Parameter                | Conditions                                 | Typical | Units |
|------------------|--------------------------|--|---------|-------|
| C <sub>IN</sub>  | Input Capacitance        | $V_{CC} = 0V$ , $V_I = 0V$ or $V_{CC}$     | 4       | pF    |
| C <sub>I/O</sub> | Input/Output Capacitance | $V_{CC} = 3.0V$ , $V_{O} = 0V$ or $V_{CC}$ | 8       | pF    |

## Note:

9. Capacitance is measured at frequency f = 1MHz, per MIL-STD-883, Method 3012.

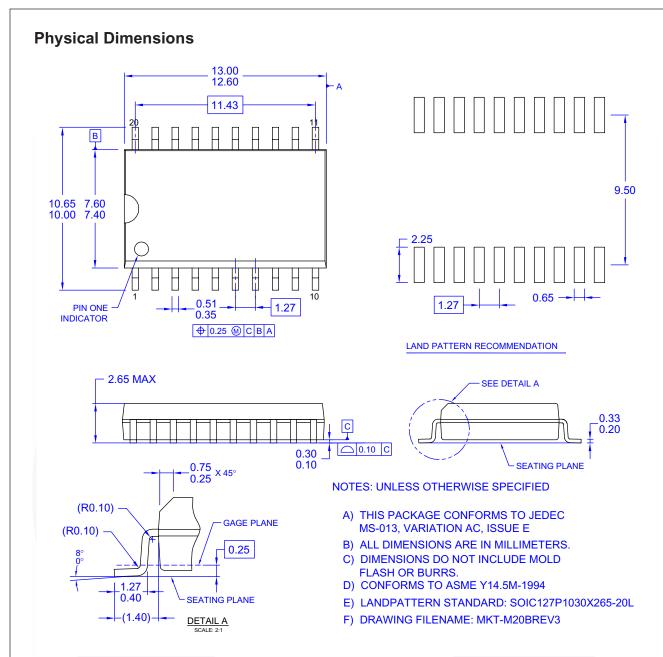


Figure 1. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

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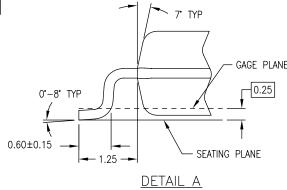
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# Physical Dimensions (Continued) 12.6±0.10 0.40 TYP -Abo 11 20 12 5.01 TYP 5.3±0.10 9.27 TYP 7.8 -B-10 3.9 △ 0.2 C B A ALL LEAD TIPS 10 PIN #1 IDENT. 0.6 TYP 1.27 TYP LAND PATTERN RECOMMENDATION ALL LEAD TIPS SEE DETAIL A 0.1 C 2.1 MAX. 1.8±0.1 -C-0.15±0.05 0.15 - 0.250.35-0.51 1.27 TYP ♦ 0.12M C A 7° TYP DIMENSIONS ARE IN MILLIMETERS GAGE PLANE

# NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION,
- CONFORMS TO EAR EDR-1/320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998. DIMENSIONS ARE IN MILLIMETERS. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.



M20DREVC

Figure 2. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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# Physical Dimensions (Continued) 5.5±0.1 -A--0.20 وحا 4.16 6,4 4.4±0.1 -B-3,2 0.42 □ 0.2 C B A 0.65 ALL LEAD TIPS PIN #1 IDENT. LAND PATTERN RECOMMENDATION O.1 C SEE DETAIL A -0.90+0.15 1.2 -C-0.09-0.20 0.1±0.05 0.65 0.19-0.30 | \$\P\$ | 0.10\P\$ | A B\$ | C\$ -12.00° R0.09min GAGE PLANE DIMENSIONS ARE IN MILLIMETERS 8 0.25 SEATING PLANE NOTES: A. CONFORMS TO JEDEC REGISTRATION MD-153, VARIATION AC, REF NOTE 6, DATE 7/93. -0.6±0.1 R0.09min B. DIMENSIONS ARE IN MILLIMETERS.

MTC20REVD1

DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.

D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

## Figure 3. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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DETAIL A





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|--------------------------|------------------------|--|
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